

	Product Dimensions				
Product Name	øA	øB	L		
	min	min	max		
B-023-00	4.3	5.6	31		
B-023-01	5.5	5.5	41		
B-023-02	7.0	8.13	39		
B-023-03	10.5	10.5	45		
B-023-04	2.4	3	19		
B-023-07	3.1	4.5	29		

MATERIALS

- 1. INSULATION SLEEVE: Heat-shrinkable, transparent clear, modified polytetrafluorethylene.
- 2. SOLDER PREFORM WITH FLUX:
 - SOLDER: TYPE Pb93 per ANSI-J-STD-006.
 - FLUX: TYPE ROM1 per ANSI-J-STD-004.
- 3. MELTABLE SEALING RINGS: Modified fluorinated ethylene propylene.

APPLICATION

- 1. These controlled soldering devices are designed for termination of a nickel plated copper shield of a cable having an insulation rated for at least 200°C continuous.
- 2. Temperature range: -65°C to +260°C. For cable preparation and installation tool, consult RPIP-666-00.

<i>₹<u>т</u>Е</i>			TITLE: SOLDERSLEEVE DEVICE SHIELD TERMINATION HIGH TEMPERATURE			
Unless otherwise specified dimensions are in millimeters. [Inches dimensions are shown in brackets] TOLERANCES: ANGLES: N/A TE Connectivity reserves the right to amend		DOCUMENT NO.: B-023-0X				
0.00 N/A 0.0 N/A 0 N/A	ROUGHNESS IN MICRON	this drawing at any time. Users should evaluate the suitability of the product for their application.		Revision : B	Issue Date : April 2020	
DRAWN BY: P.TALLY	CAGE CODE: 06090	date: 27-Aug-07	ECO: ECO-20-004960	SCALE: NTS	SIZE: A	SHEET: 1 of 1

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TE Connectivity:

B-023-00 B-023-00-55-22-9 B-023-02 B-023-07-55-22-9 B-023-01 B-023-04 B-023-07 B-023-03CS1643